PC357N Series

Mini-flat Package, **General Purpose Photocoupler**



Description

PC357N Series contains an IRED optically coupled to a phototransistor.

It is packaged in a 4-pin Mini-flat package. Input-output isolation voltage(rms) is 3.75kV. Collector-emitter voltage is 80V(*) and CTR is 50%

to 600% at input current of 5mA.

Features

- 1. 4-pin Mini-flat package
- 2. Double transfer mold package (Ideal for Flow Soldering)
- 3. High collector-emitter voltage (V_{CEO} : 80V^(*))
- 4. Current transfer ratio (CTR) : MIN. 50% at I_F=5mA, $V_{CF}=5V$
- 5. Several CTR ranks available
- 6. High isolation voltage between input and output
 - $(V_{iso(rms)}: 3.75kV)$
 - (*) Up to Date code "P9" (September 2002) $V_{\mbox{\tiny CEO}}$: 35V. From the production Date code "J5" (May 1997) to "P9" (September 2002), however the products were screened by BV_{CEO}≥70V.

Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. PC357)
- 2. Package resin : UL flammability grade (94V-0)

Applications

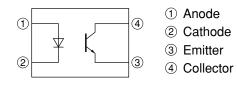
- 1. Hybrid substrates that require high density mounting
- 2. Programmable controllers

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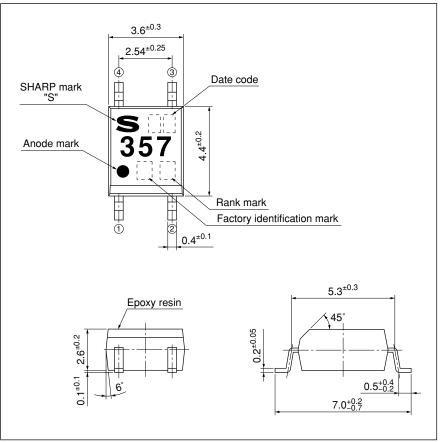


Internal Connection Diagram



Outline Dimensions





Product mass : approx. 0.1g



Date code (2 digit)

	1st o	digit		2nd digit			
	Year of p	roduction		Month of production			
A.D.	Mark	A.D	Mark	Month	Mark		
1990	A	2002	Р	January	1		
1991	В	2003	R	February	2		
1992	C	2004	S	March	3		
1993	D	2005	Т	April	4		
1994	Е	2006	U	May	5		
1995	F	2007	V	June	6		
1996	Н	2008	W	July	7		
1997	J	2009	Х	August	8		
1998	K	2010	А	September	9		
1999	L	2011	В	October	0		
2000	М	2012	С	November	N		
2001	N	:	÷	December	D		

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin	
no mark	Ismon	
	Japan	
	Indonesia	
$\overline{\nabla}$	Philippines	
	China	

* This factory marking is for identification purpose only. Please contact the local SHARP sales representative to see the actual status of the production

Rank mark

Refer to the Model Line-up table

■ Absolute Maximum Ratings

	■ Absolute Maximum Ratings (T _a =25°						
	Parameter	Symbol	Rating	Unit			
	Forward current	$\begin{tabular}{ c c c c c } \hline Symbol & Rating \\ \hline I_F & 50 \\ \hline nt & I_{FM} & 1 \\ \hline V_R & 6 \\ \hline P & 70 \\ \hline ge & V_{CEO} & ^{*4} & 80 \\ \hline ge & V_{CEO} & ^{*4} & 80 \\ \hline ge & V_{ECO} & 6 \\ \hline I_C & 50 \\ \hline n & P_C & 150 \\ \hline n & P_{C} & 150 \\ \hline n & P_{tot} & 170 \\ \hline T_{opr} & -30 \ to +100 \\ \hline T_{stg} & -40 \ to +125 \\ \hline V_{iso \ (rms)} & 3.75 \\ \hline \end{tabular}$	mA				
Input	*1 Peak forward current	I _{FM}	1	Α			
Inț	Reverse voltage	VR	6	V			
	Power dissipation	Р	70	mW			
	Collector-emitter voltage	V _{CEO}	*4 80	V			
Output	Emitter-collector voltage	V _{ECO}	6	V			
Out	Collector current	I _C	50	mA			
	Collector power dissipation	Pc	150	mW			
1	Fotal power dissipation	P _{tot}	170	mW			
(Operating temperature	T _{opr}	-30 to +100	°C			
S	Storage temperature	T _{stg}	-40 to +125	°C			
* ² I	solation voltage	V _{iso (rms)}	3.75	kV			
*3 🤆	Soldering temperature	T _{sol}	260	°C			

*1 Pulse width≤100µs, Duty ratio : 0.001 *2 40 to 60%RH, AC for 1 minute, f=60Hz

*3 For 10s

*4 Up to Date code "P9" (September 2002) V_{CEO} :35V.

■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

	Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward voltage		$V_{\rm F}$	I _F =20mA	-	1.2	1.4	V
Input	Reverse current		I _R	V _R =4V	-	_	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
	Collector dark current		I _{CEO}	V_{CE} =50V, I_{F} =0	-	-	100	nA
Output	Collector-emitter breakdown voltage		BV _{CEO}	$I_{C}=0.1 \text{mA}, I_{F}=0$	*5 80	_	_	V
	Emitter-collector breakdown voltage		BV _{ECO}	$I_{E}=10\mu A, I_{F}=0$	6	_	_	V
	Collector current		I _C	$I_F=5mA, V_{CE}=5V$	2.5	5	30	mA
	Collector-emitter saturation voltage		V _{CE (sat)}	$I_F=20mA$, $I_C=1mA$	-	0.1	0.2	V
Transfer charac- teristics	Isolation resistance		R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	1×10^{11}	_	Ω
	Floating capacitance		C_{f}	V=0, f=1MHz	-	0.6	1.0	pF
	Despense time	Rise time	t _r		_	4	18	μs
	Response time	Fall time	t _f	$V_{CE}=2V$, $I_C=2mA$, $R_L=100\Omega$	_	3	18	μs

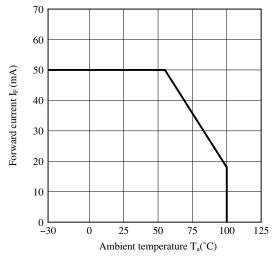
*5 From the production Date code "J5" (May 1997) to "P9" (September 2002), however the products were screened by BV_{CEO}≥70V.

■ Model Line-up

Package	Tap	oing	Rank mark	$I_{C} [mA]$ $(I_{F}=5mA, V_{CE}=5V, T_{a}=25^{\circ}C)$	
	3 000pcs/reel	750pcs/reel			
	PC357N	PC357NT	with or without	2.5 to 30.0	
	PC357N1	PC357N1T	А	4.0 to 8.0	
	PC357N2	PC357N2T	В	6.5 to 13.0	
	PC357N3	PC357N3T	С	10.0 to 20.0	
Model No.	PC357N4	PC357N4T	D	15.0 to 30.0	
WIGUEI NO.	PC357N5	PC357N5T	A or B	4.0 to 13.0	
	PC357N6	PC357N6T	B or C	6.5 to 20.0	
	PC357N7	PC357N7T	C or D	10.0 to 30.0	
	PC357N8	PC357N8T	A, B or C	4.0 to 20.0	
	PC357N9	PC357N9T	B, C or D	6.5 to 30.0	
	PC357N0	PC357N0T	A, B, C or D	4.0 to 30.0	

Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.

Fig.1 Forward Current vs. Ambient Temperature





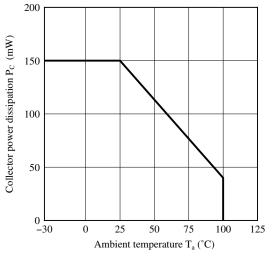


Fig.5 Peak Forward Current vs. Duty Ratio

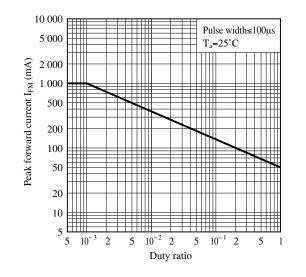


Fig.2 Diode Power Dissipation vs. Ambient Temperature

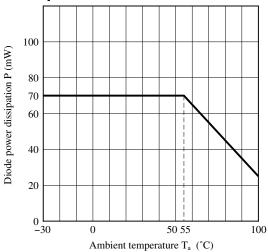
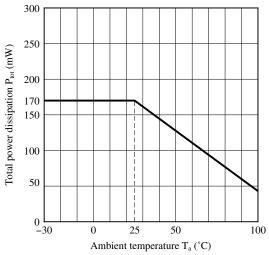


Fig.4 Total Power Dissipation vs. Ambient Temperature





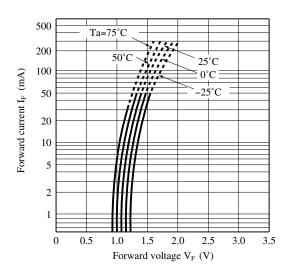
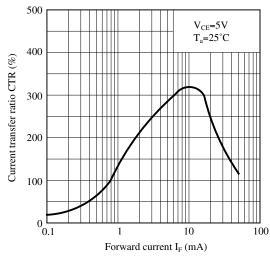
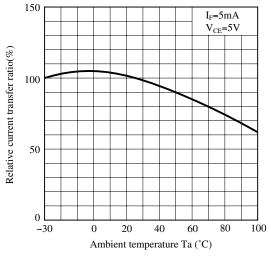




Fig.7 Current Transfer Ratio vs. Forward Current









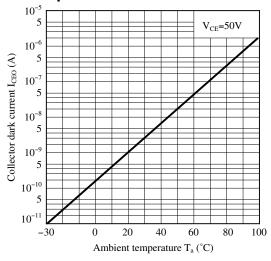


Fig.8 Collector Current vs. Collector-emitter Voltage

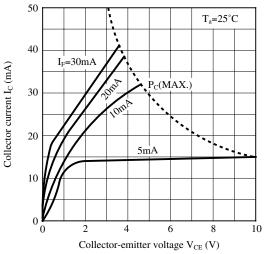
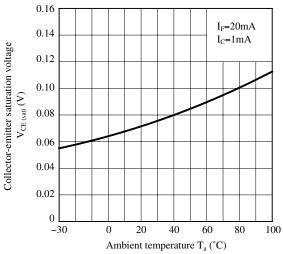
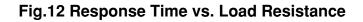


Fig.10 Collector - emitter Saturation Voltage vs. Ambient Temperature





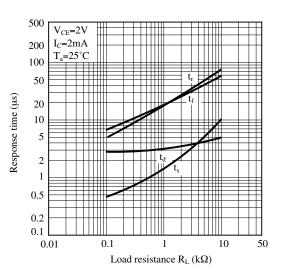




Fig.13 Test Circuit for Response Time

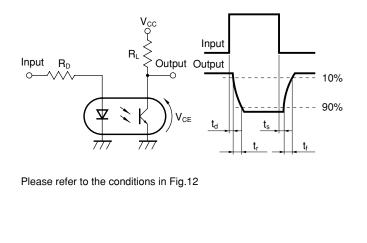
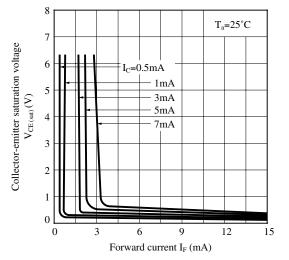


Fig.14 Collector-emitter Saturation Voltage vs. Forward Current



Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.



Design Considerations

• Design guide

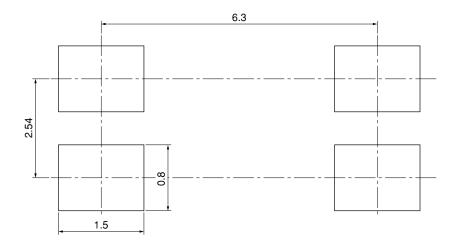
While operating at I_{F} <1.0mA, CTR variation may increase. Please make design considering this fact.

This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photocouplers will degrade over time. In the case of long term operation, please take the general IRED degradation (50% degradation over 5years) into the design consideration.

Recommended Foot Print (reference)



(Unit : mm)

☆ For additional design assistance, please review our corresponding Optoelectronic Application Notes.

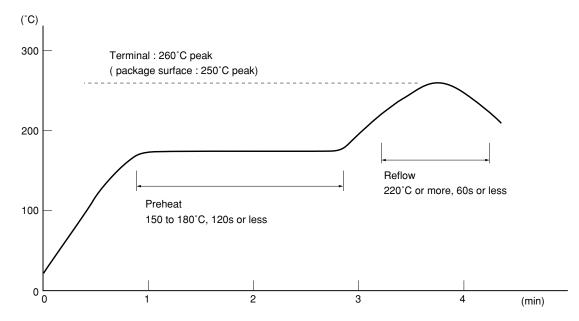


Manufacturing Guidelines

Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below. Soldering should not exceed the curve of temperature profile and time. Please don't solder more than twice.



Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s. Preheating is within the bounds of 100 to 150°C and 30 to 80s. Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C. Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



• Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

• Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



Package specification

• Tape and Reel package

1. 3 000pcs/reel

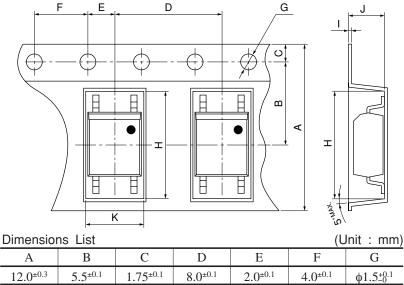
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

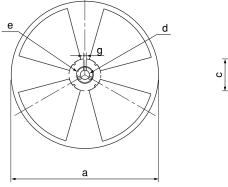
Reel : PS

Carrier tape structure and Dimensions



_	А	B	C	D	E	F	G
	$12.0^{\pm 0.3}$	$5.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$8.0^{\pm 0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 - 8
	Н	Ι	J	K			
	$7.4^{\pm 0.1}$	$0.3^{\pm 0.05}$	$3.1^{\pm 0.1}$	$4.0^{\pm 0.1}$			

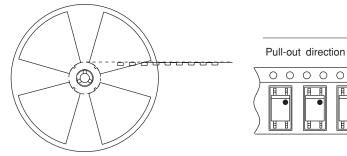
Reel structure and Dimensions



o	
f b	

Dimensio	ons List	(Unit : mm)		
а	b	c	d	
370	13.5 ^{±1.5}	80 ^{±1.0}	13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}		

Direction of product insertion



[Packing: 3 000pcs/reel]



2.750pcs/reel

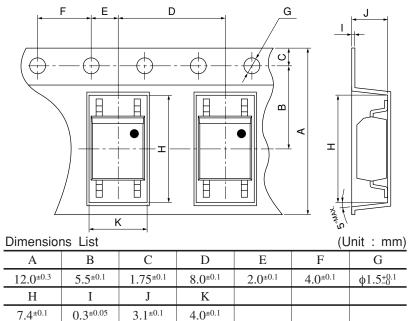
Package materials

Carrier tape : A-PET (with anti-static material)

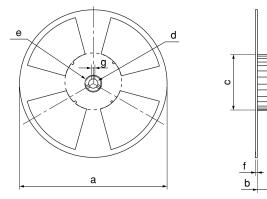
Cover tape : PET (three layer system)

Reel : PS

Carrier tape structure and Dimensions

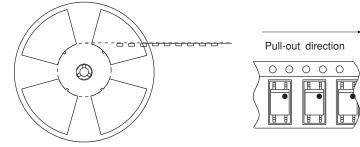


Reel structure and Dimensions



Dimensio	ns List	(Unit : mm)		
а	b	с	d	
180	180 13.5 ^{±1.5}		13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	$2.0^{\pm 0.5}$	$2.0^{\pm 0.5}$		

Direction of product insertion



[Packing : 750pcs/reel]

SHARP

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- --- Personal computers
- --- Office automation equipment
- --- Telecommunication equipment [terminal]
- --- Test and measurement equipment
- --- Industrial control
- --- Audio visual equipment
- --- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.

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- --- Telecommunication equipment [trunk lines]
- --- Nuclear power control equipment
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